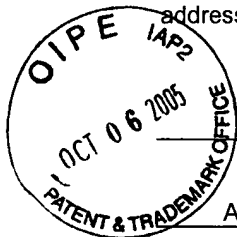


I hereby certify that this correspondence is being deposited with the United States Postal Service, with sufficient postage, as first class mail in an envelope addressed to:



Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450  
on October 4, 2005

Date of Deposit

Anthony P. Curtis, Ph.D., Reg. No. 46,193

Name of applicant, assignee or  
Registered Representative

Signature

Date of Signature

Our Case No. 10322/57

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kuang Chien Hsieh et al.

Serial No. 10/680,509

Filing Date: October 7, 2003

For ADHESIVE BONDING WITH LOW  
TEMPERATURE GROWN  
AMORPHOUS OR  
POLYCRYSTALLINE COMPOUND  
SEMICONDUCTORS

Examiner: Vikki Trinh

Group Art Unit No. 2811

## AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of May 11, 2005, please amend the application as follows:

**Amendments to the Claims** begin on page 2 of this paper.

**Remarks** are provided on page 9 of this paper.